





PCB Number: TIDA-00532 PCB PCB PCB Rev: Rev3 LOGO LOGO Texas Instruments Pb-Free Symbol Label Table Label Text 001 TIDA-00532 ZZ2

Assembly Note

These assemblies are ESD sensitive, ESD precautions shall be observed. ZZ3

Assembly Note

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable. ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified. Orderable: N/A Designed for Public Release Mod. Date: 3/30/2015
TD #: 00532 Project Title: LM3281 Comobo
Number: TIDA-00532 Rev: ScH Sheet Title:

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